

## **DUPONT™ OFXXA SERIES**

#### LEAD FREE RESISTOR COMPOSITION

## PRODUCT DESCRIPTION

Designed to give an ideal balance of properties, DuPont™ 0FXXA series has been specifically developed for Chip Resistor Applications. It meets the market needs for smaller sized resistors and greener products.

#### **PRODUCT BENEFITS**

- Lead free\* and Cadmium free\*
- Excellent performance for smaller chip sizes with thinner printed thickness
- · Good power handling stability
- Excellent ESD stability
- High speed laser trimmable
- Narrow TCR gap

#### TYPICAL PERFORMANCE PROPERTIES

| Product Name | Blending Group | Resistivity $\Omega/\text{sq}^1$ |               | HTCR ppm/°C2 | CTCR ppm/°C2 | Viscosity Pa.s <sup>3</sup> |
|--------------|----------------|----------------------------------|---------------|--------------|--------------|-----------------------------|
| 0F01A        | Lower-ohm      | 1                                | 0.75 - 1.25   | +/- 100      | +/- 100      | 150 - 240                   |
| 0F10A        |                | 10                               | 7.5 - 12.5    | +/- 100      | +/- 100      | 150 - 240                   |
| 0F20A        |                | 100                              | 75 - 125      | +/- 100      | +/- 100      | 150 - 240                   |
| 0F30A        |                | 1K                               | 0.75K - 1.25K | +/- 100      | +/- 100      | 150 - 240                   |
| 0F40A        |                | 10K                              | 11.3K - 18.8K | +/- 100      | +/- 100      | 150 - 240                   |
| 0F39A        | Higher-ohm     | 1.4K                             | 1.05K – 1.75K | +/- 100      | +/- 100      | 150 - 240                   |
| 0F49A        |                | 10K                              | 6.6K - 11.0K  | +/- 100      | +/- 100      | 150 - 240                   |
| 0F59A        |                | 100K                             | 75K - 125K    | +/- 100      | +/- 100      | 150 - 240                   |
| 0F69A        |                | 1M                               | 0.75M - 1.25M | +/- 100      | +/- 100      | 150 - 240                   |
| 0F79A        |                | 10M                              | 9.0M - 13.0M  | +/- 100      | +/- 100      | 150 - 240                   |

¹Shipping specification: Resistors are printed with dried thickness 11-13um. Printed on DuPont™ 5421E termination (12-14µm dried thickness). Fired in DuPont standard QA firing profile with 850°C peak for 10 minutes. Resistor geometry is 0.5mm x 0.5mm except 0F01A (8sq.)

#### RECOMMENDED PROCESSING CONDITIONS

## **Substrates**

Reported properties are based on tests with 96% alumina substrates. Substrates of other composition may yield variation in performance properties.

#### **Termination**

0FXXA resistors were designed for use with high silver-containing terminations like DuPont™ 5421E Ag/Pd conductor. Reported properties were obtained using DuPont™ 5421E Ag/Pd termination. Use of different terminations may cause a shift of resistance and TCR values.

#### **Blending**

Adjacent members of each blending group are blendable. It is also blendable with DuPont™ 00LXX lead free lower ohm resistor members in good linearity.

#### **Printing**

Properties of 0FXXA series are based on resistors printed to 11-13 $\mu$ m dried thickness. 250-325 mesh screen with 5-25 $\mu$ m emulsion is recommended.

<sup>\*</sup>Lead and cadmium "free" as used herein means that these are not intentionally added to the referenced products. Trace amounts, however, may be present.

<sup>&</sup>lt;sup>2</sup>Temperature Coefficient of Resistance from +25 to +125°C for Hot TCR and -55 to +25°C for Cold TCR.

<sup>&</sup>lt;sup>3</sup>Brookfield HAT, SC4-14/6R, @10rpm



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#### **Thinner**

0FXXA resistors have been optimized for screen printing and thinning is not normally required or recommended. DuPont™ 8250 thinner may be added sparingly to compensate for evaporative losses.

#### **Drying**

Parts should be allowed to level at room temperature for 5-10 minutes and then dried for 10-15 minutes at 150°C.

#### **Firing**

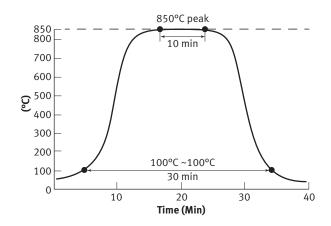
Properties are based on a 30-minute firing cycle (100°C - 100°C) with 10 minutes at a peak temperature of 850°C DuPont standard profile.

#### Storage and Shelf Life

Containers should be stored, tightly sealed, in a clean, stable environment at room temperature between 5°C - 30°C. Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

#### Safety and Handling

For Safety and Handling information pertaining to this product, read the Material Safety Data Sheet (MSDS).



# FOR MORE INFORMATION ON DUPONT™ OFXXA OR OTHER DUPONT MICROCIRCUIT MATERIALS, PLEASE CONTACT YOUR LOCAL REPRESENTATIVE:

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